

PCF8563

Real-time clock/calendar

16 April 1999

Product specification

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

1. General description

The PCF8563 is a CMOS real-time clock/calendar optimized for low power consumption. A programmable clock output, interrupt output and voltage-low detector are also provided. All address and data are transferred serially via a two-line bidirectional I²C-bus. Maximum bus speed is 400 kbits/s. The built-in word address register is incremented automatically after each written or read data byte.

2. Features

- Provides year, month, day, weekday, hours, minutes and seconds based on 32.768 kHz quartz crystal
- Century flag
- Wide operating supply voltage range: 1.0 to 5.5 V
- Low back-up current; typical 0.25 μA at V_{DD} = 3.0 V and T_{amb} = 25 °C
- 400 kHz two-wire I²C-bus interface (at V_{DD} = 1.8 to 5.5 V)
- Programmable clock output for peripheral devices: 32.768 kHz, 1024 Hz, 32 Hz and 1 Hz
- Alarm and timer functions
- Voltage-low detector
- Integrated oscillator capacitor
- Internal power-on reset
- I²C-bus slave address: read A3H; write A2H
- Open drain interrupt pin.

3. Applications

- Mobile telephones
- Portable instruments
- Fax machines
- Battery powered products.





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4. Quick reference data

Table 1: Quick reference data

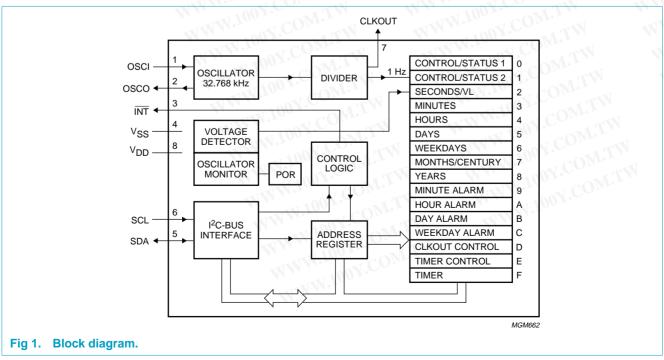
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage operating mode	I ² C-bus inactive; T _{amb} = 25 °C	1.0	5.5	V
		I^2 C-bus active; $f_{SCL} = 400 \text{ kHz}$; $T_{amb} = -40 \text{ to } +85 \text{ °C}$	1.8	5.5	VIV
I _{DD}	supply current; timer and CLKOUT	f _{SCL} = 400 kHz	W.V	800	μΑ
	disabled	f _{SCL} = 100 kHz	-111	200	μΑ
		f _{SCL} = 0 Hz; T _{amb} = 25 °C			
		V _{DD} = 5 V	A.W.	550	nA
		V _{DD} = 2 V	WW	450	nA
T _{amb}	operating ambient temperature	TIWW.Inv COM.	-40	+85	°C
T _{stg}	storage temperature	M. 100 T. COM: 1	-65	+150	°C
					~ + + + -

5. Ordering information

Table 2: Ordering information

Type number	Package	Ton COW:	WWW.
	Name	Description	Version
PCF8563P	DIP8	plastic dual in-line package; 8 leads (300 mil)	SOT97-1
PCF8563T	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1
PCF8563TS	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3.0 mm	SOT505-1

6. Block diagram



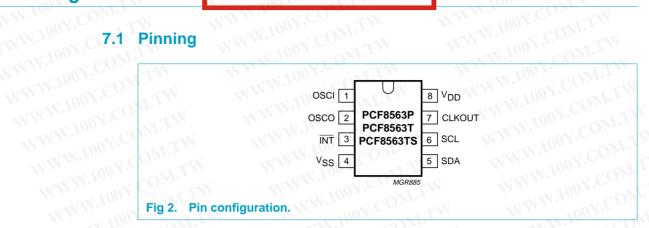
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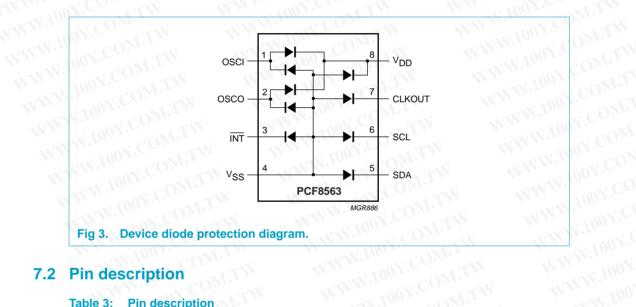
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WWW.100Y.COM 7. Pinning information

WWW.100Y.C(7.1 **Pinning**





7.2 Pin description

Table 3: Pin description

Symbol	Pin	Description
OSCI (100	oscillator input
osco 💉	2	oscillator output
ĪNT	3	interrupt output (open-drain; active LOW)
V _{SS}	4	ground
SDA	5	serial data I/O
SCL	6	serial clock input
CLKOUT	7	clock output (open-drain)
V_{DD}	8	positive supply

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8. Functional description

The PCF8563 contains sixteen 8-bit registers with an auto-incrementing address register, an on-chip 32.768 kHz oscillator with an integrated capacitor, a frequency divider which provides the source clock for the Real-Time Clock (RTC), a programmable clock output, a timer, an alarm, a voltage-low detector and a 400 kHz I²C-bus interface.

All 16 registers are designed as addressable 8-bit parallel registers although not all bits are implemented. The first two registers (memory address 00H and 01H) are used as control and/or status registers. The memory addresses 02H through 08H are used as counters for the clock function (seconds up to year counters). Address locations 09H through 0CH contain alarm registers which define the conditions for an alarm. Address 0DH controls the CLKOUT output frequency. 0EH and 0FH are the timer control and timer registers, respectively.

The Seconds, Minutes, Hours, Days, Months, Years as well as the Minute alarm, Hour alarm and Day alarm registers are all coded in BCD format. The Weekdays and Weekday alarm register are not coded in BCD format.

When one of the RTC registers is read the contents of all counters are frozen. Therefore, faulty reading of the clock/calendar during a carry condition is prevented.

8.1 Alarm function modes

By clearing the MSB (bit AE = Alarm Enable) of one or more of the alarm registers, the corresponding alarm condition(s) will be active. In this way an alarm can be generated from once per minute up to once per week. The alarm condition sets the alarm flag, AF (bit 3 of Control/Status 2 register). The asserted AF can be used to generate an interrupt $(\overline{\text{INT}})$. Bit AF can only be cleared by software.

8.2 Timer

The 8-bit countdown timer (address 0FH) is controlled by the Timer Control register (address 0EH; see Table 25). The Timer Control register selects one of 4 source clock frequencies for the timer (4096, 64, 1, or $^{1}/_{60}$ Hz), and enables/disables the timer. The timer counts down from a software-loaded 8-bit binary value. At the end of every countdown, the timer sets the timer flag TF (see Table 7). The timer flag TF can only be cleared by software. The asserted timer flag TF can be used to generate an interrupt ($\overline{\text{INT}}$). The interrupt may be generated as a pulsed signal every countdown period or as a permanently active signal which follows the condition of TF. TI/TP (see Table 7) is used to control this mode selection. When reading the timer, the current countdown value is returned.

8.3 CLKOUT output

A programmable square wave is available at the CLKOUT pin. Operation is controlled by the CLKOUT frequency register (address 0DH; see Table 23). Frequencies of 32.768 kHz (default), 1024, 32 and 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator. CLKOUT is an open-drain output and enabled at power-on. If disabled it becomes high-impedance.

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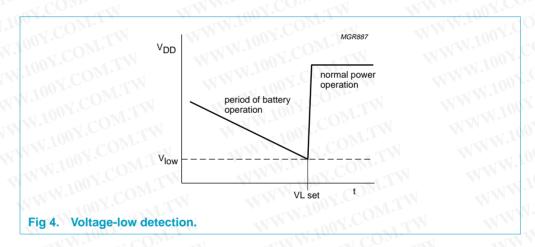
8.4 Reset

The PCF8563 includes an internal reset circuit which is active whenever the oscillator is stopped. In the reset state the I²C-bus logic is initialized and all registers, including the address pointer, are cleared with the exception of bits FE, VL, TD1, TD0, TESTC and AE which are set to logic 1.

8.5 Voltage-low detector and clock monitor

The PCF8563 has an on-chip voltage-low detector. When V_{DD} drops below V_{low} the VL bit (Voltage Low, bit 7 in the Seconds register) is set to indicate that reliable clock/calendar information is no longer guaranteed. The VL flag can only be cleared by software.

The VL bit is intended to detect the situation when V_{DD} is decreasing slowly for example under battery operation. Should V_{DD} reach V_{low} before power is re-asserted then the VL bit will be set. This will indicate that the time may be corrupted.



8.6 Register organization

Table 4: Registers overview

Bit positions labelled as '-'are not implemented; those labelled with '0' should always be written with logic 0.

Address	Register name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
00H	Control/Status 1	TEST1	0	STOP	110	TESTC	00%	0	0
01H	Control/Status 2	0	0	0.0	TI/TP	AF	TF	AIE	TIE
0DH	CLKOUT frequency	FE	WAN JA	-CO	T. T.	- 1/1	N.M.	FD1	FD0
0EH	Timer control	TE	W.	² CC	M	- **	MATO	TD1	TD0
0FH	Timer countdown value			1100 A.G.	timer count	tdown value>	WWW.I		

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Table 5: BCD formatted registers overview

Address	Register name	BCD form	at tens nik	oble (00)		BCD format units nibble			
		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		2 ³	2 ²	21	20	23	2 ²	2 ¹	20
02H	Seconds	VL	*	MM.I	<secor< td=""><td>nds 00 to 59</td><td>coded in BCD</td><td>)></td><td>COLLA</td></secor<>	nds 00 to 59	coded in BCD)>	COLLA
03H	Minutes	DM=		<minutes 00="" 59="" bcd="" coded="" in="" to=""></minutes>					
04H	Hours	ONEIL	_	<hours 00="" 23="" bcd="" coded="" in="" to=""></hours>					
05H	Days		_	<days 01="" 31="" bcd="" coded="" in="" to=""></days>					
06H	Weekdays	<u>-</u> M.7	W -	4 M	100Y	T.M.T	<we< td=""><td>ekdays 0 to 6</td><td>>[1]</td></we<>	ekdays 0 to 6	>[1]
07H	Months/Century	СС	TVI	₹\\\\\	100	<month< td=""><td>s 01 to 12 cod</td><td>ded in BCD></td><td></td></month<>	s 01 to 12 cod	ded in BCD>	
D8H	Years	A'COM	TW	WY	<years 00<="" td=""><td>to 99 coded</td><td>in BCD></td><td></td><td></td></years>	to 99 coded	in BCD>		
09H	Minute alarm	AE	1. 1	< XI	<minute< td=""><td>alarm 00 to 5</td><td>59 coded in Bo</td><td>CD></td><td>· CC</td></minute<>	alarm 00 to 5	59 coded in Bo	CD>	· CC
0AH	Hour alarm	AE	W.F.			our alarm 00	0 to 23 coded	in BCD>	
0BH	Day alarm	AE	UN=III		<(day alarm 01	to 31 coded i	in BCD>	
0CH	Weekday alarm	AE	- 1 T T	_	MA.	1007.	<week< td=""><td>day alarm 0 to</td><td>o 6 > [1]</td></week<>	day alarm 0 to	o 6 > [1]

^[1] Not coded in BCD.

8.6.1 Control/Status 1 register

Control/Status 1 register bits description (address 00H)

Bit	Symbol	Description
7 WW.100	TEST1	TEST1 = 0; normal mode. TEST1 = 1; EXT_CLK test mode; see Section 8.7.
5	STOP	STOP = 0; RTC source clock runs. STOP = 1; all RTC divider chain flip-flops are asynchronously set to logic 0; the RTC clock is stopped (CLKOUT at 32.768 kHz is still available).
3 WWW	TESTC	TESTC = 0; power-on reset override facility is disabled (set to logic for normal operation). TESTC = 1; power-on reset override is enabled.
6, 4, 2 to 0	0	By default set to logic 0.

WWW.100

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WWW.100Y.COM.TW 8.6.2 Control/Status 2 register WWW.100Y.COM.

Table 7: Description of Control/Status 2 register bits description (address 01H)

7 to 5	0	By default set to logic 0.	
4	TI/TP	TI/TP = 0: INT is active when TF is active (subject to the status of TIE).	
		TI/TP = 1: INT pulses active according to Table 8 (subject to the status of TIE). Note that if AF and AIE are active then INT will be permanently active.	
3	AF	When an alarm occurs, AF is set to logic 1. Similarly, at the end of a	
ZOM.T COM.J Y.COM	N TF TN TW A.TN	timer countdown, TF is set to logic 1. These bits maintain their value until overwritten by software. If both timer and alarm interrupts are required in the application, the source of the interrupt can be determined by reading these bits. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access. See Table 9 for the value descriptions of bits AF and TF.	
1 Y.CO	AIE	Bits AIE and TIE activate or deactivate the generation of an interrupt	
0 TIE		when AF or TF is asserted, respectively. The interrupt is the logical OR of these two conditions when both AIE and TIE are set.	
		AIE = 0: alarm interrupt disabled; AIE = 1: alarm interrupt enabled.	
		TIE = 0: timer interrupt disabled; TIE = 1: timer interrupt enabled.	

Source clock (Hz)	INT [1] period (s)	
	n [2] = 1	n>1
1096	1/8192	1/4096
4 N. 100 Y. CO.	1/128	1/64
NWW. COV.CO	1/64	1/64
60	1/64	CO 1/64

R/W	Bit: Al	W. T. CONT. TW	Bit: T	MI TOOK CONTAIN
	Value	Description	Value	Description
Read	0	alarm flag inactive	0	timer flag inactive
	1	alarm flag active	1	timer flag active
Write	0	alarm flag is cleared	0	timer flag is cleared
	1	alarm flag remains unchanged	1	timer flag remains unchanged

^[2] n = loaded countdown timer value. Timer stopped when n = 0.

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WWW.100Y.COM.TW 8.6.3 Seconds, Minutes and Hours registers Table 10: 0

.100Y.COM.TW Table 10: Seconds/VL register bits description (address 02H)

7' LTW	VL	VL = 0: reliable clock/calendar information is guaranteed; VL = 1: reliable clock/calendar information is no longer guaranteed.
6 to 0	<seconds></seconds>	These bits represent the current seconds value coded in BCD format; value = 00 to 59.
		Example: <seconds> = 101 1001, represents the value 59 s.</seconds>

Bit	Symbol	Description
7 COM	<u>'}}</u> '	not implemented
6 to 0	<minutes></minutes>	These bits represent the current minutes value coded in BCI format; value = 00 to 59.

Table 12: Hours register bits description (address 04H)

Bit	Symbol	Description
7 to 6	G-M.TW	not implemented
5 to 0	<hours></hours>	These bits represent the current hours value coded in BCD format; value = 00 to 23.
Days, We	eekdays, Mo	onths/Century and Years registers
Table 13:	Davs registe	er bits description (address 05H)

8.6.4 Days, Weekdays, Months/Century and Years registers

Table 13: Days register bits description (address 05H)

Bit	Symbol	Description
7 to 6	TON.CO	not implemented
5 to 0	<days></days>	These bits represent the current day value coded in BCD format; value = 01 to 31.
		The PCF8563 compensates for leap years by adding a 29th day to February if the year counter contains a value which is exactly divisible by 4, including the year '00'.

Bit	Symbol	Description
7 to 3	4111	not implemented
2 to 0	<weekdays></weekdays>	These bits represent the current weekday value 0 to 6; see Table 15.
		These bits may be re-assigned by the user.

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A. A.	Http://www.100y.com.t	w	Real-time clock
Table 15: W	eekday assignments	WW.	
Day	Bit 2	Bit 1	Bit 0
Sunday	M. TOW.	0	MM. Jon COM
Monday	W. 100 COM.T	0	WW.1001. CO.
Tuesday	MM 0001	1	0
Wednesday	0,007.00	TW 1	1007.1
Thursday	WWY1. COM	0	MM 100.0C
Friday	1 N. No. CO.	0	WWW. of.
Saturday	1W.100	1	0

Bit	Symbol	Description
007.CO	C	Century bit. C = 0; indicates the century is 20xx. C = 1; indicates the century is 19xx. 'xx' indicates the value held in the Years register; see Table 18.
		This bit is toggled when the Years register overflows from 99 to 00. These bits may be re-assigned by the user.
6 to 5	COMITY	not implemented
4 to 0	<months></months>	These bits represents the current month value coded in BCD format; value = 01 to 12; see Table 17.

Table 17: Month assignments

Month	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
January	0	0	10	0 10	1
February	0 1	0	0,01	1	0
March	Y.CO TV	0	0,001	NT.TN	1
April	(CO)	N 0	WW 1	Y.CO O TW	0
May	00/1	0	WW1	V.CO	N 1 W
June	OCOM.	0	111.10	COM	0
July	100 0 COM	0	1, W.1	1011	1
August	1000	1.11	0	100 J. O. O.M	0
September	0 Y.C	M.T1N	0	100 0	1.TW 1
October	1 1 CU	0	0	1000.00	0
November	W.1 C	0 0	0	OY.CO	TI
December	W 1100	0 0	0	VVI 1 V.C	0

Table 18: Years register bits description (address 08H)

Bit	Symbol	Description
7 to 0	<years></years>	This register represents the current year value coded in BCD format; value = 00 to 99.

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WWW.100Y.COM.TW WWW.100V.CO 8.6.5 **Alarm registers** WWW.100Y.COM.

When one or more of the alarm registers are loaded with a valid minute, hour, day or weekday and its corresponding AE (Alarm Enable) bit is a logic 0, then that information will be compared with the current minute, hour, day and weekday. When all enabled comparisons first match, the bit AF (Alarm Flag) is set.

AF will remain set until cleared by software. Once AF has been cleared it will only be set again when the time increments to match the alarm condition once more. Alarm registers which have their AE bit set at logic 1 will be ignored.

Table 19: Minute alarm register bits description (address 09H)

Bit	Symbol	Description
7	AE	AE = 0; minute alarm is enabled. AE = 1; minute alarm is disabled.
6 to 0	<minute alarm=""></minute>	These bits represents the minute alarm information coded in BCD format; value = 00 to 59.

WWW.100

Bit Symbol	Description
7 AE	AE = 0; hour alarm is enabled. AE = 1; hour alarm is disabled.
6 to 0 <hour alarm=""></hour>	These bits represents the hour alarm information coded in BCI
6 to 0 <nour alarm=""></nour>	format; value = 00 to 23.

Table 21: Day alarm register bits description (address 0BH)

Bit	Symbol	Description
7	AE	AE = 0; day alarm is enabled. AE = 1; day alarm is disabled.
6 to 0	<day alarm=""></day>	These bits represents the day alarm information coded in BCD format; value = 01 to 31.

Table 22: Weekday alarm register bits description (address 0CH)

Symbol	Description
AEIW.100Y.C	AE = 0; weekday alarm is enabled. AE = 1; weekday alarm is disabled.
<weekday alarm=""></weekday>	These bits represents the weekday alarm information value 0 to 6.
	AE

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8.6.6 CLKOUT frequency register

Table 23: CLKOUT frequency register bits description (address 0DH)

Bit	Symbol	Description
7	FE	FE = 0; the CLKOUT output is inhibited and the CLKOUT output is set to high-impedance. FE = 1; the CLKOUT output is activated.
6 to 2	- WW	not implemented
1	FD1	These bits control the frequency output (f _{CLKOUT}) on the CLKOUT
0	FD0	pin; see Table 24.

Table 24: CLKOUT frequency selection

FD1	FD0	f _{CLKOUT}	WW.100X.CON
Y.CO. O.W	0	32.768 kHz	WW 1007.00
V.CONO TW	11	1 024 Hz	MANATIONICO
CONT.	0	32 Hz	MAN W. TOUX CC
COL	1 1 W	1 Hz	WWW.IV.C

8.6.7 Countdown timer registers

The Timer register is an 8-bit binary countdown timer. It is enabled and disabled via the Timer control register bit TE. The source clock for the timer is also selected by the Timer control register. Other timer properties, e.g. interrupt generation, are controlled via the Control/status 2 register. For accurate read back of the countdown value, the I²C-bus clock SCL must be operating at a frequency of at least twice the selected timer clock.

Table 25: Timer control register bits description (address 0EH)

Bit	Symbol	Description
7	TE	TE = 0; timer is disabled. TE = 1; timer is enabled.
6 to 2	1. 100 Y.C	not implemented
1 WW	TD1	Timer source clock frequency selection bits. These bits determine
0	TD0	the source clock for the countdown timer, see Table 26. When not in use, TD1 and TD0 should be set to '11' (1/60 Hz) for power saving.

Table 26: Timer source clock frequency selection

TD1	TD0	Timer source clock frequency (Hz)
0	100,0	4096
0	1001.00	64
1 WW	0 / .C	1 TW WWW. 100 Y. CO.
1	1 CC	1/60

Table 27: Timer countdown value register bits description (address 0FH)

Bit	Symbol	Description
7 to 0	<timer countdown="" value=""></timer>	This register holds the loaded countdown value 'n'.
		Countdown period = $\frac{n}{\text{Source clock frequency}}$

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8.7 EXT CLK test mode

A test mode is available which allows for on-board testing. In this mode it is possible to set up test conditions and control the operation of the RTC.

The test mode is entered by setting bit TEST1 in the Control/Status1 register. The CLKOUT pin then becomes an input. The test mode replaces the internal 64 Hz signal with the signal that is applied to the CLKOUT pin. Every 64 positive edges applied to CLKOUT will then generate an increment of one second.

The signal applied to the CLKOUT pin should have a minimum pulse width of 300 ns and a minimum period of 1000 ns. The internal 64 Hz clock, now sourced from CLKOUT, is divided down to 1 Hz by a 2⁶ divide chain called a pre-scaler. The pre-scaler can be set into a known state by using the STOP bit. When the STOP bit is set, the pre-scaler is reset to 0. STOP must be cleared before the pre-scaler can operate again. From a STOP condition, the first 1 s increment will take place after 32 positive edges on CLKOUT. Thereafter, every 64 positive edges will cause a 1 s increment.

Remark: Entry into EXT_CLK test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the pre-scaler can be made.

8.7.1 Operation example

- 1. Enter the EXT_CLK test mode; set bit 7 of Control/Status 1 register (TEST = 1)
- 2. Set bit 5 of Control/Status 1 register (STOP = 1)
- 3. Clear bit 5 of Control/Status 1 register (STOP = 0)
- Set time registers (Seconds, Minutes, Hours, Days, Weekdays, Months/Century and Years) to desired value
- 5. Apply 32 clock pulses to CLKOUT
- 6. Read time registers to see the first change
- 7. Apply 64 clock pulses to CLKOUT
- 8. Read time registers to see the second change.

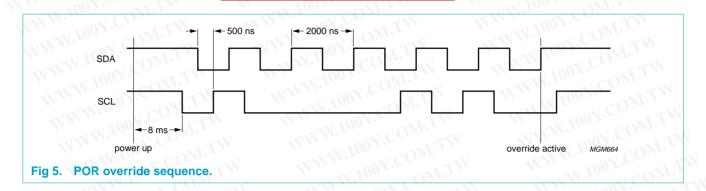
Repeat steps 7 and 8 for additional increments.

8.8 Power-On Reset (POR) override mode

The POR duration is directly related to the crystal oscillator start-up time. Due to the long start-up times experienced by these types of circuits, a mechanism has been built in to disable the POR and hence speed up on-board test of the device. The setting of this mode requires that the I²C-bus pins, SDA and SCL, be toggled in a specific order as shown in Figure 5. All timing values are required minimum.

Once the override mode has been entered, the chip immediately stops being reset and normal operation starts i.e. entry into the EXT_CLK test mode via I²C-bus access. The override mode is cleared by writing a logic 0 to bit TESTC. Re-entry into the override mode is only possible after TESTC is set to logic 1. Setting TESTC to logic 0 during normal operation has no effect except to prevent entry into the POR override mode.

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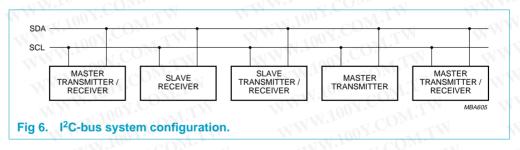
8.9 Serial interface

The serial interface of the PCF8563 is the I²C-bus. A detailed description of the I²C-bus specification, including applications, is given in the brochure: *The I²C-bus and how to use it.* order no. 9398 393 40011 or I²C Peripherals Data Handbook IC12.

8.9.1 Characteristics of the I²C-bus

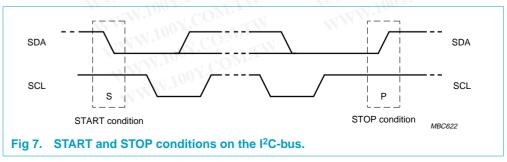
The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

The I²C-bus system configuration is shown in Figure 6. A device generating a message is a 'transmitter', a device receiving a message is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves'.



8.9.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P); see Figure 7.

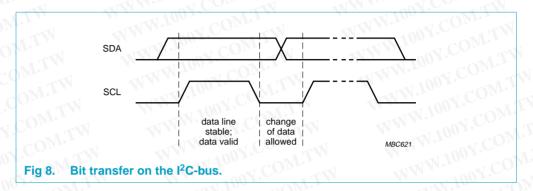


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8.9.3 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal; see Figure 8.



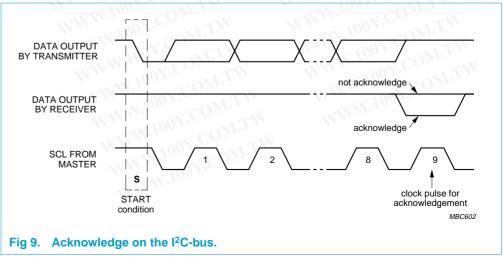
8.9.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges must pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.



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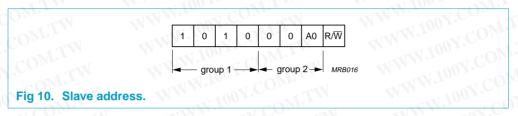
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8.9.5 I²C-bus protocol

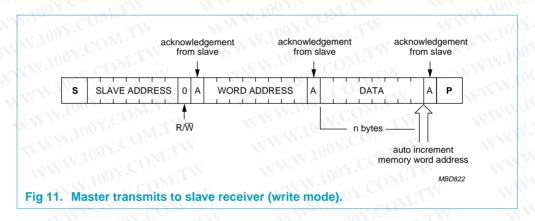
Addressing: Before any data is transmitted on the I²C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the start procedure.

The PCF8563 acts as a slave receiver or slave transmitter. Therefore the clock signal SCL is only an input signal, but the data signal SDA is a bidirectional line.

The PCF8563 slave address is shown in Figure 10.

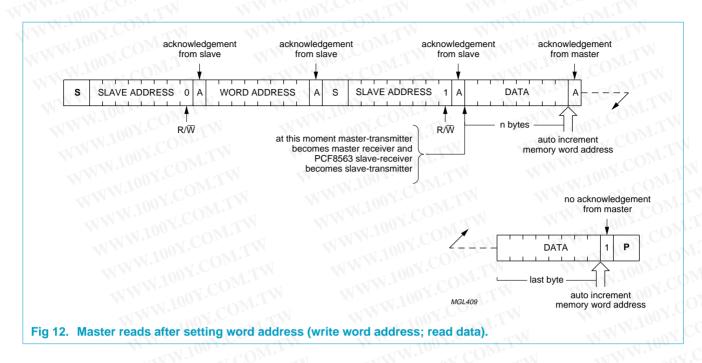


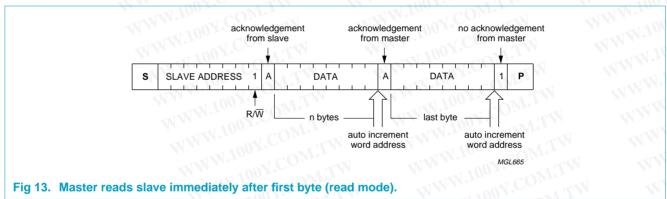
Clock/calendar read/write cycles: The I²C-bus configuration for the different PCF8563 read and write cycles are shown in Figure 11, 12 and 13. The word address is a four bit value that defines which register is to be accessed next. The upper four bits of the word address are not used.



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9. Limiting values

Table 28: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions Min	Max	Unit
V_{DD}	supply voltage	-0.5	+6.5	V
I _{DD}	supply current	-50	+50	mA
V _I	input voltage on inputs SCL and SDA	-0.5	6.5	V
	input voltage on input OSCI	−0.5	V _{DD} + 0.5	V
V _O	output voltage on outputs CLKOUT and $\overline{\text{INT}}$	-0.5	6.5	V
ı	DC input current at any input	-10	+10	mA
0	DC output current at any output	-10	+10	mA
P _{tot}	total power dissipation	_	300	mW
T _{amb}	operating ambient temperature	-40	+85	°C
T _{stg}	storage temperature	-65	+150	°C

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10. Static characteristics

Table 29: Static characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 to 85 °C; f_{OSC} = 32.768 kHz; quartz R_s = 40 k Ω ; C_L = 8 pF; unless otherwise specified.

Symbol Symbol	Parameter	Conditions	W	Min	Тур	Max	Unit
Supplies	raiailletei	Conditions		IVIIII	ТУР	IVIAX	Olin
V_{DD}	supply voltage	I^2 C-bus inactive; $T_{amb} = 25 ^{\circ}$ C	(T)	1.0[1]	_/////	5.5	V
		I^2 C-bus active; $f_{SCL} = 400 \text{ kHz}$		1.8[1]	- 4/4	5.5	V
	supply voltage for reliable clock/calendar information	T _{amb} = 25 °C)M	V_{low}	- 111	5.5	CO
DD1	supply current;	f _{SCL} = 400 kHz	[2]	TI.	_	800	μΑ
	CLKOUT disabled (FE = 0)	f _{SCL} = 100 kHz		WI.TW	-	200	μΑ
		f _{SCL} = 0 Hz; T _{amb} = 25 °C	[2]	TIME	V	WW TIL	00 X .
		V _{DD} = 5 V	I.C	OBL	275	550	nA
		V _{DD} = 3 V	V.	GOM	250	500	nA
		$V_{DD} = 2 V$		LOM.	225	450	nA
		f _{SCL} = 0 Hz	[2]	CON		-111	W.100
		V _{DD} = 5 V	00	<u> </u>	500	750	nA
		V _{DD} = 3 V		ON.CO	400	650	nA
		$V_{DD} = 2 V$. 1	mY.C	400	600	nA
DD2	supply current;	f _{SCL} = 0 Hz; T _{amb} = 25 °C	[2]	ov.C	OW		MW
552	CLKOUT enabled	V _{DD} = 5 V	W	<u> 700 - </u>	825	1600	nA
	$(f_{CLKOUT} = 32 \text{ kHz}; FE = 1)$	V _{DD} = 3 V		100, 1	550	1000	nA
		V _{DD} = 2 V		- 1700,	425	800	nA
		f _{SCL} = 0 Hz	[2]	100	N.C.	TW	V
		V _{DD} = 5 V	W	1	950	1700	nA
		V _{DD} = 3 V	- ' - (N)	MAN	650	1100	nA
		V _{DD} = 2 V	- "	-WW.	500	900	nA
nputs	W	W.1007. COM.7		VV	100 T. C	OM	
V _{IL}	LOW-level input voltage	100X. COM.TW		V _{SS}	N.400 Y.	0.3V _{DD}	V
√ _{IH}	HIGH-level input voltage	WIT 100Y COMITW		$0.7V_{DD}$	100 y	V_{DD}	V
LI	input leakage current	$V_I = V_{DD}$ or V_{SS}		-1 W	= 1003	+1	μΑ
C _i	input capacitance	WWW. TOW. CONT. TW	[3]	- W	M74.	7.7	pF
Outputs		TIWW.100 COM.			MM·In	COM.	
OL(SDA)	LOW-level output current; pin SDA	$V_{OL} = 0.4 \text{ V}; V_{DD} = 5 \text{ V}$		-3	WWW.M	100 Y.COM	mA
OL(INT)	LOW-level output current; pin INT	MMM. TOOX.COM.		–1	AMM	-	mA
OL(CLKOUT)	LOW-level output current; pin CLKOUT		-	-1	-	-	mA

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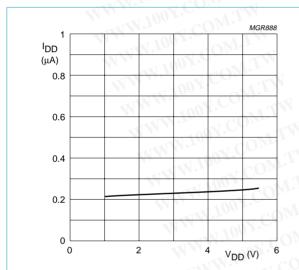
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Table 29: Static characteristics...continued

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 to 85 °C; f_{OSC} = 32.768 kHz; quartz R_s = 40 k Ω ; C_L = 8 pF; unless otherwise specified.

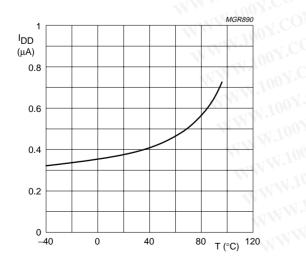
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{OH(CLKOUT)}	HIGH-level output current; pin CLKOUT	$V_{OH} = 4.6 \text{ V}; V_{DD} = 5 \text{ V}$	M.TW 1	WWW.	.100Y.C	mA
I _{LO}	output leakage current	$V_O = V_{DD}$ or V_{SS}		ZIVI	1+1	μА
Voltage de	tector					
V _{low}	voltage-low detection level	T _{amb} = 25 °C	ON. TAN	0.9	1.0	Y.C.V
		77 .7 1110	- 70 10 10			

- [1] For reliable oscillator start-up at power-up: $V_{DD(min)power-up} = V_{DD(min)} + 0.3 \text{ V}$.
- [2] Timer source clock = $\frac{1}{60}$ Hz; SCL and SDA = V_{DD} .
- [3] Tested on sample basis.



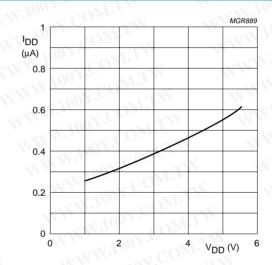
T_{amb} = 25 °C; Timer = 1 minute.

Fig 14. I_{DD} as a function of V_{DD}; CLKOUT disabled.



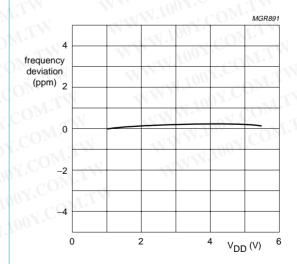
 $V_{DD} = 3 V$; Timer = 1 minute.

Fig 16. I_{DD} as a function of T_{amb} ; CLKOUT = 32 kHz.



T_{amb} = 25 °C; Timer = 1 minute.

Fig 15. I_{DD} as a function of V_{DD} ; CLKOUT = 32 kHz.



 T_{amb} = 25 °C; normalized to V_{DD} = 3 V.

Fig 17. Frequency deviation as function of V_{DD}.

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11. Dynamic characteristics

Table 30: Dynamic characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 to +85 °C; f_{OSC} = 32.768 kHz; quartz R_s = 40 k Ω ; C_L = 8 pF; unless otherwise specified.

		A TOOL TO			<u> </u>	
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Oscillator	W.100Y. COM.TW	M. 100 F. COW. 1		1.WW.1		OM.
C _{L(integrated)}	integrated load capacitance		15	25	35	pF
$\Delta f_{OSC}/f_{OSC}$	oscillator stability	ΔV_{DD} = 200 mV; T_{amb} = 25 °C	TV	2×10^{-7}	1 ±007.	
Quartz crys	stal parameters (f _{OSC} = 32.768	kHz)				CO
R _s	series resistance		-W	- WW	40	kΩ
C _L	parallel load capacitance	I TWW.IOU CO	Mr. -	10	171.700	pF
C _T	trimmer capacitance	W 100 1	5	_	25	pF
CLKOUT or	ıtput	W 1001.		_	TAIN!	
δ_{CLKOUT}	CLKOUT duty factor	TAN MM 100X	[1]	50	N Z	%
I ² C-bus tim	ing characteristics [2]	TW WYW 100Y	CO T		MM.	1100Y
f _{SCL}	SCL clock frequency	WWW.	[3]	rv i	400	kHz
t _{HD;STA}	START condition hold time	W.T. M. TOO	0.6	TV.	- 1111	μs
t _{SU;STA}	set-up time for a repeated START condition	OW.TW WWW.II	0.6	W.T.N	- W	μs
t_{LOW}	SCL LOW time	CONTRACTOR WINN	1.3	WIT	- 1	μs
t _{HIGH}	SCL HIGH time	COM	0.6	WT.	- <	μs
t _r	SCL and SDA rise time	COM	N.TO- C	ON.	0.3	μs
t _f	SCL and SDA fall time	CONTACT	W.100	CO_{M-1}	0.3	μs
C _b	capacitive bus line load	DY.COM.TW	W.400Y	COMIT	400	pF
t _{SU;DAT}	data set-up time	NT.NO.	100	T.M.	<u> </u>	ns
t _{HD;DAT}	data hold time	ONY.CONTY	0	Y.Com	TAN	ns
t _{SU;STO}	set-up time for STOP condition	N.CON.	4.0	W-COM.	TW	μs
t _{SW}	tolerable spike width on bus	1.10v = COM.	W.W.	CON	50	ns

^[1] Unspecified for f_{CLKOUT} = 32.768 kHz.

^[2] All timing values are valid within the operating supply voltage range at T_{amb} and referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD}.

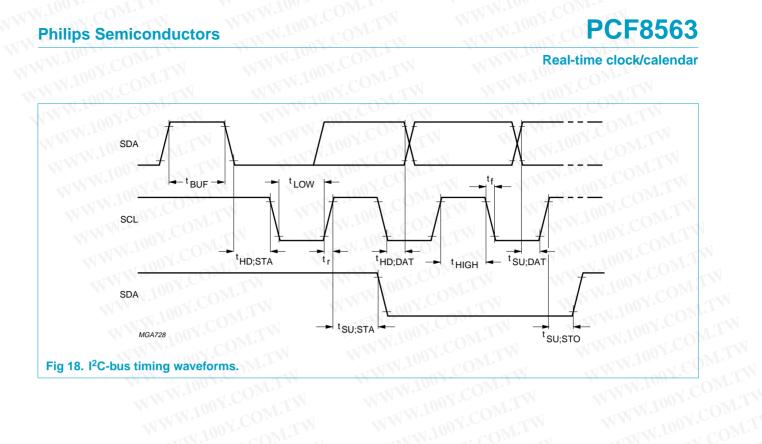
^[3] I²C-bus access time between two STARTs or between a START and a STOP condition to this device must be less than one second.

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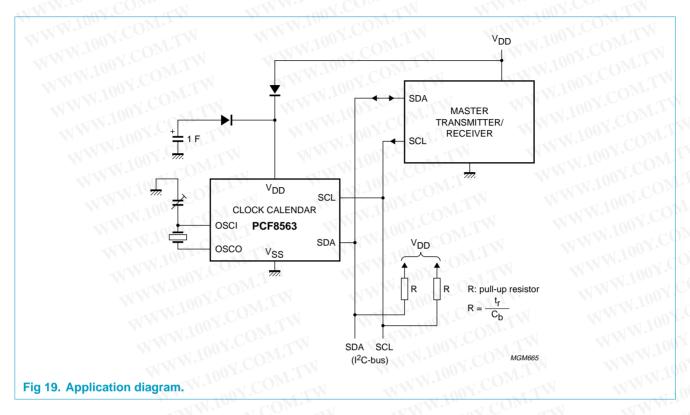
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12. Application information



12.1 Quartz crystal frequency adjustment

Method 1: Fixed OSCI capacitor — By evaluating the average capacitance necessary for the application layout a fixed capacitor can be used. The frequency is best measured via the 32.768 kHz signal available after power-on at the CLKOUT pin. The frequency tolerance depends on the quartz crystal tolerance, the capacitor tolerance and the device-to-device tolerance (on average $\pm 5 \times 10^{-6}$).

Average deviations of ±5 minutes per year can be easily achieved.

Method 2: OSCI trimmer — The oscillator is tuned to the required accuracy by adjusting a trimmer capacitor on pin OSCI and measuring the 32.768 kHz signal available after power-on at the CLKOUT pin.

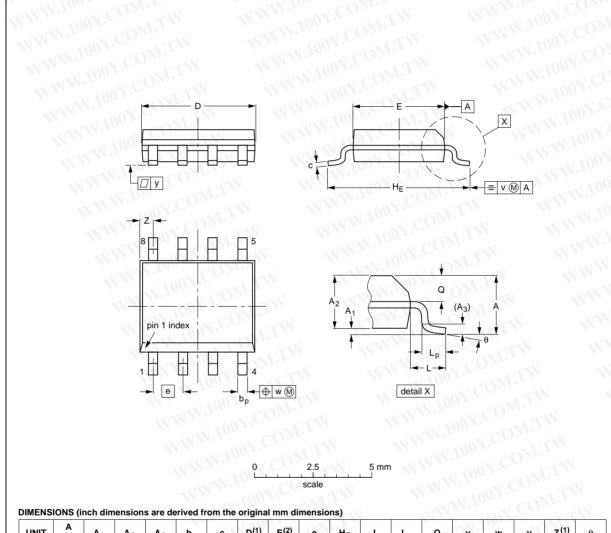
Method 3: OSCO output — Direct output measurement on pin OSCO (accounting for test probe capacitance).

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13. Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	NL	Lp	Q	V	w	y	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.20 0.19	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	· OM. I	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT96-1	076E03S	MS-012AA	MMiles			95-02-04 97-05-22

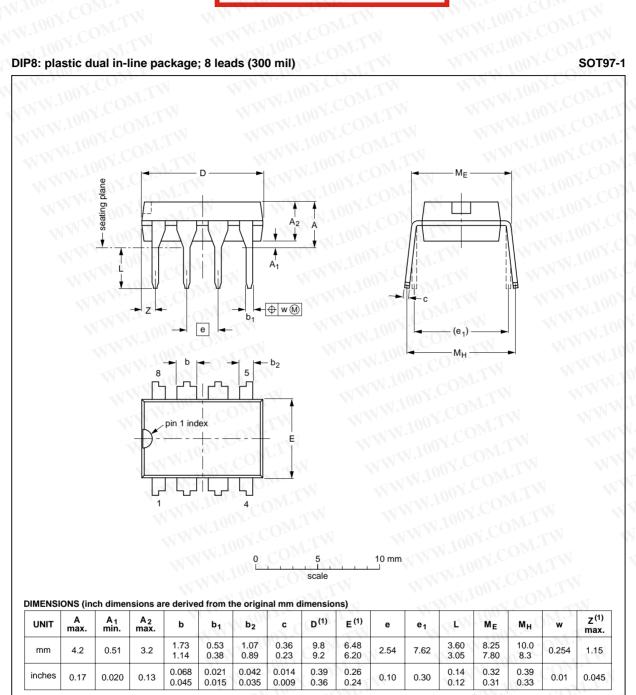
Fig 20. SOT96-1.

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DIP8: plastic dual in-line package; 8 leads (300 mil)

SOT97-1



Note

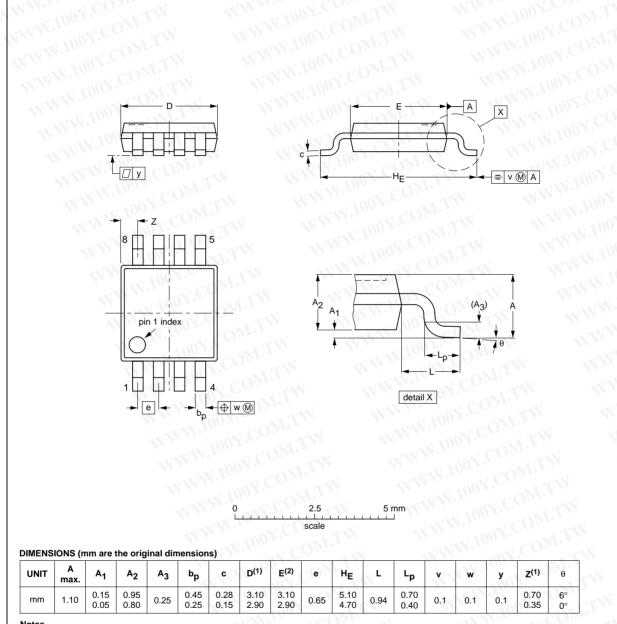
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFE	RENCES	Oly and a second	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	OM:I	PROJECTION	ISSUE DATE
SOT97-1	050G01	MO-001AN	W.100Y.	OM.TW		92-11-17 95-02-04

Fig 21. SOT97-1.

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

VERSION IEC JEDEC EIAJ PROJECTION 1930E DATE SOT505-1 99-04-09	OUTLIN	E		REFE	RENCES	OMr.	EUROPEAN	ISSUE DATE
SOT505-1 99-04-09	VERSIO	N	IEC	JEDEC	EIAJ	MIT	PROJECTION	1330E DATE
	SOT505	-1		W	W.100Y.	WI.MO		99-04-09

Fig 22. SOT505-1.

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14. Soldering

14.1 Introduction

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26; Integrated Circuit Packages* (document order number 9398 652 90011).

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mount components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

14.2 Surface mount packages

14.2.1 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 230 °C.

14.2.2 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners. Philips Semiconductors PCF8563

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During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

14.2.3 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

14.3 Through-hole mount packages

14.3.1 Soldering by dipping or by solder wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joints for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature $(T_{stg(max)})$. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

14.3.2 Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 $^{\circ}$ C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 $^{\circ}$ C, contact may be up to 5 seconds.

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14.4 Package related soldering information

Table 31: Suitability of IC packages for wave, reflow and dipping soldering methods

Mounting	Package	Soldering method					
	MM. Ing - COW. I	Wave	Reflow [1]	Dipping			
Through-hole mount	DBS, DIP, HDIP, SDIP, SIL	suitable [2]	1700 Å'C.	suitable			
Surface mount	BGA, SQFP	not suitable	suitable	TM			
	HLQFP, HSQFP, HSOP, HTSSOP, SMS	not suitable [3]	suitable	COM			
	PLCC [4], SO, SOJ	suitable	suitable	= coN			
	LQFP, QFP, TQFP	not recommended [4] [5]	suitable	<u>7</u> .			
	SSOP, TSSOP, VSO	not recommended [6]	suitable	Day.Co			
		ACMAN.	-417/10	- (1			

- [1] All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods.
 - [2] For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.
 - [3] These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
 - [4] If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
 - [5] Wave soldering is only suitable for LQFP, QFP and TQFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
 - [6] Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

15. Revision history

Date CPCN	Description
990416 -	This data sheet supersedes the version of 1998 Mar 25 (9397 750 03282):
	 The format of this specification has been redesigned to comply with Philips Semiconductors new presentation and information standard
	Added Figure 3 "Device diode protection diagram." on page 3
	Added Figure 4 "Voltage-low detection." on page 5
	 Added paragraph in Section 8.5 "Voltage-low detector and clock monitor" on page 5
	Added Figure 14 to 17 on page 18 in Section 10.
	Added Figure 14 to 17 on page 18 in Section 10.

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16. Data sheet status

Datasheet status	Product status	Definition [1]			
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.			
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.			
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.			

[1] Please consult the most recently issued data sheet before initiating or completing a design.

17. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

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